

¸ ¨H C

2SD1815

Rev.B Jan.-

/ Electrical Characteristic Curve

Fig. 1 - Static Characteristics

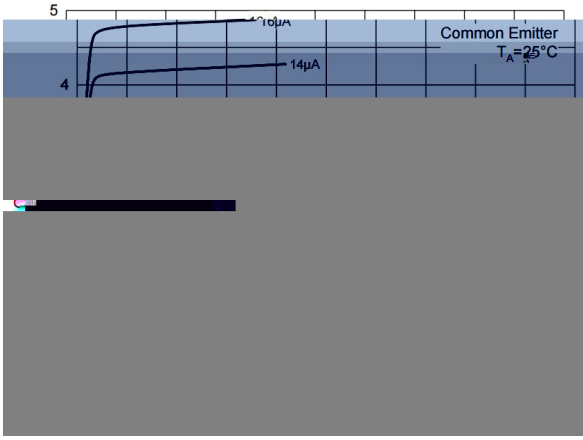


Fig. 2 - DC Current Gain Characteristics

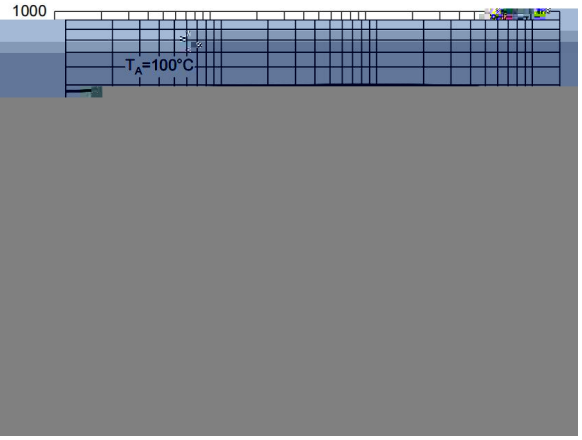
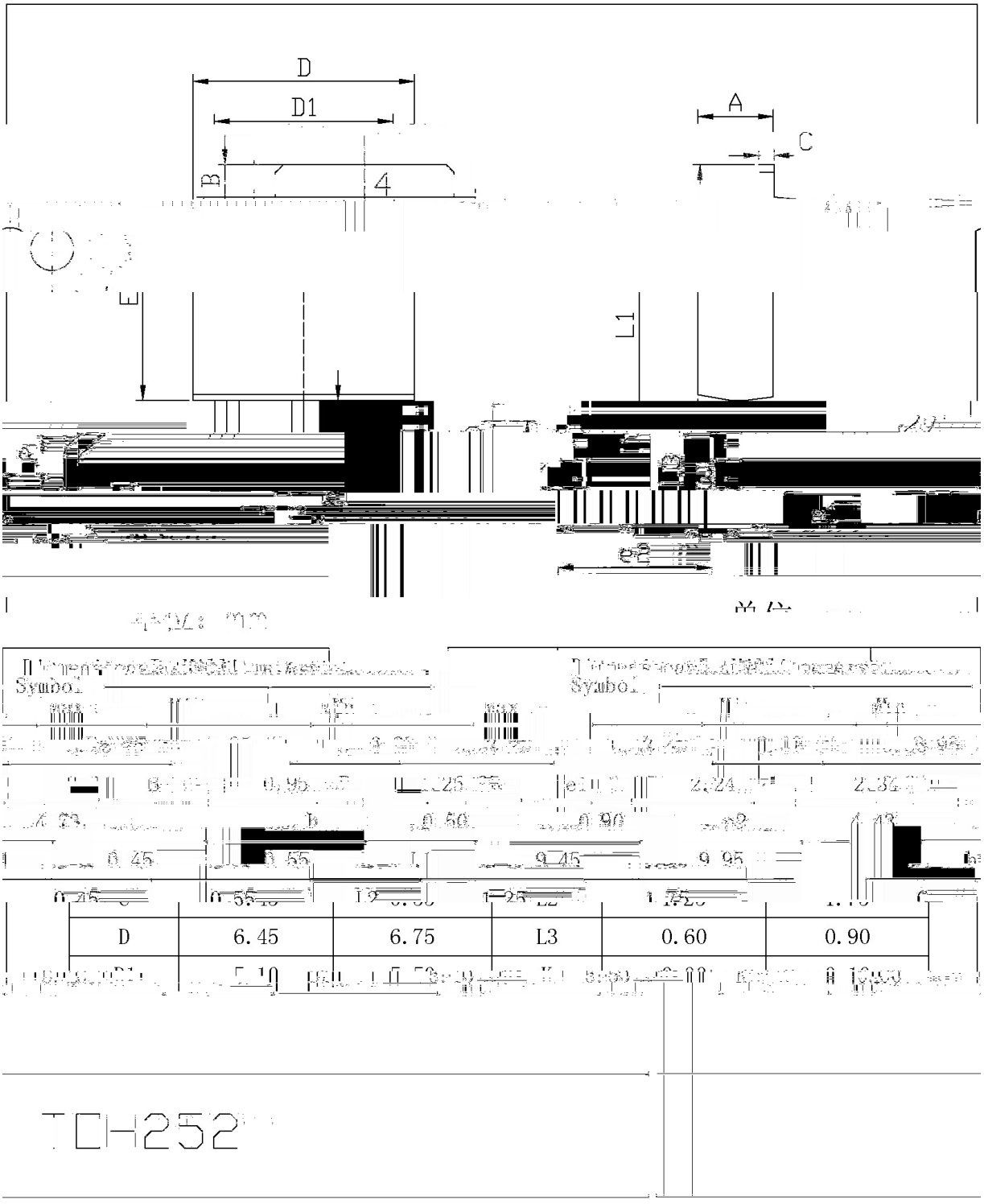


Fig. 3 - Collector-Emitter Saturation



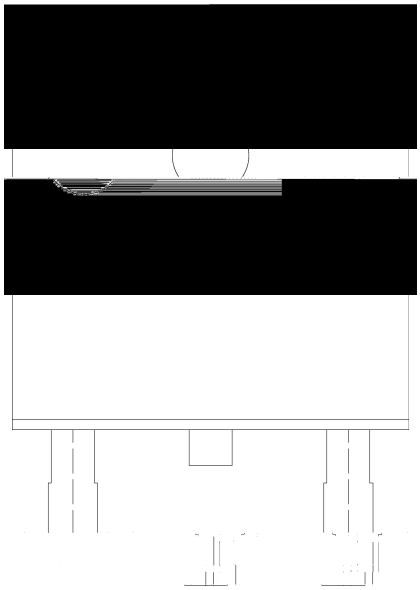


/ Package Dimensions

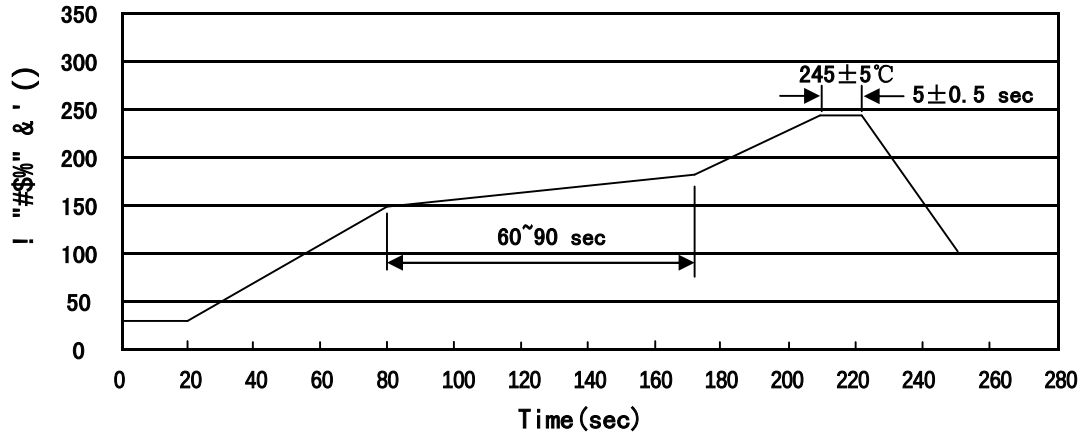


D	6.45	6.75	L3	0.60	0.90

/ Marking



( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



1	150	180	60 90sec;	1.Preheating:150~180℃, Time:60~90sec.
2	245±5		5±0.5sec;	2.Peak Temp.:245±5℃, Duration:5±0.5sec.
3		2	10℃/sec.	3. Cooling Speed: 2~10℃/sec.

Note:

/ Resistance to Soldering Heat Test Conditions

260±5℃ 10±1 sec. Temp.:260±5℃ Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension		(unit mm³)
	/	Reels/Inner Box /	Units/Inner Box	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
TO-252	2,500	2	5,000	6	30,000	13″ ×16	360×360×50	380×335×366

/ TUBE

Package Type	Units					Dimension		(unit mm³)
	U	Tubes/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Tube	Inner Box	Outer Box
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	575×290×180